

# Technical Data

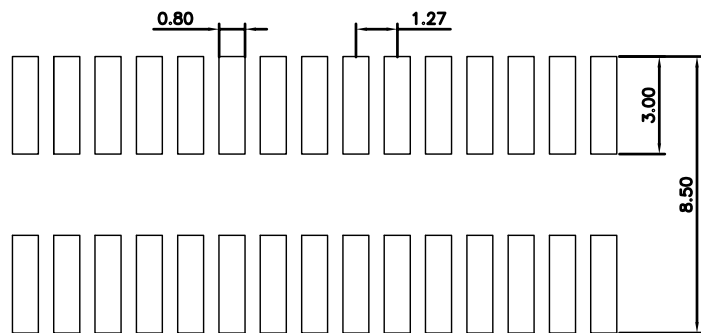
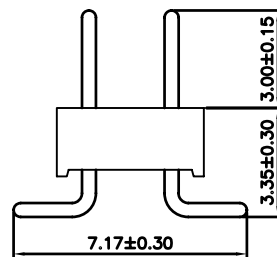
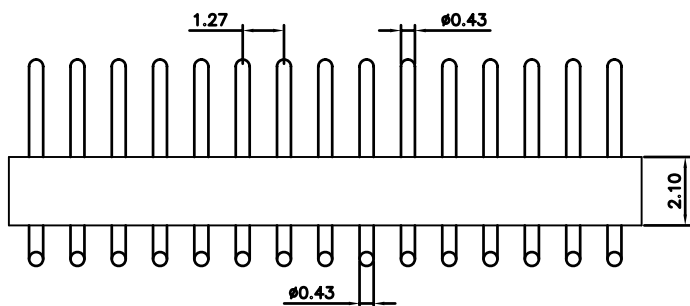
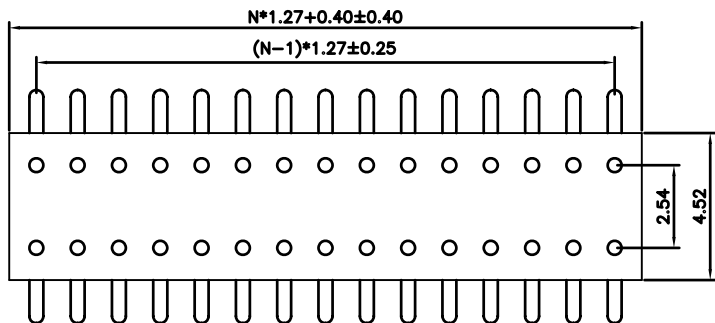
Material:  
 Pin(outer sleeve): Brass,machined CuZn38Pb2  
 Plating(outer sleeve):  
 Tin plated:2μm/80μ"Ni, 5μm/200μ"Sn  
 Gold Plated:2μm/80μ"Ni,Full gold  
 Insulator(black): Black (PA46) UL94V-0

Electrical:  
 Current rating: 1Amps/contact max.  
 Contact resistance: ≤4mΩ/contact  
 Insulation resistance: ≥1000MΩ at V=500V  
 Dielectric Withstanding Voltage: 1000V AC Min  
 Operating voltage: 60VAC/DC

Mechanical:  
 Operating temperatures: Gold Plated:-55° C to+125° C  
 Tin plated:-40° C to+105° C  
 Soldering temperature: +260° C,10s max.

HCSP-VX-2Xxx-LF  
 LEADFREE

RoHS Compliant



P.C.B LAYOUT

**MORETHANALL**  
 CONNECTORS  
 ASSEMBLIES

煜倫股份有限公司

PART NO. HCSP-VX-2Xxx		CHECKED BY CY	TOLERANCES ARE .X ± 0.2 .XX ± .XXX ± AWG	DESCRIP TION: Pitch 1.27mm Sip Socket Double Row SMT Pin Length 8.20mm		
DWG NO. HCSP-VX-2Xxx						
FILE NO.		DRAWING BY	AREA	REVISIONS	HK	DATE
UNIT / mm	SCALE 1:1	PROJECTION				